6N138

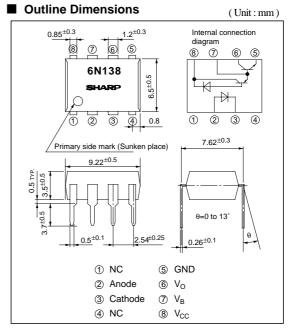
Features

- 1. High current transfer ratio (CTR : MIN. 300% at I_F=1.6mA)
- 2. High speed response ($t_{PHL}1$: TYP. 2µs at $R_L=2.2k\Omega$)
- 3. Instantaneous common mode rejection voltage (CM_H : TYP. 500V/µs)
- 4. TTL compatible output
- 5. Recognized by UL, file No. E64380

Applications

- 1. Interfaces for computer peripherals
- 2. Measuring instruments, Control equipment
- 3. Telephone sets
- 4. Signal transmission between circuits of different potentials and impedances

High Sensitivity, High Speed *OPIC Photocoupler



* "OPIC" (Optical IC) is a trademark of the SHARP Corporation. An OPIC consists of a light-detecting element and signalprocessing circuit integrated onto a single chip.

	Absolute	Maximum	Ratings	
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ADSOIL	ute Maximum Ratings			(Ta=25°C)
	Parameter		Rating	Unit
	Forward current	$I_{\rm F}$	20	mA
	^{*1} Peak forward current	$I_{\rm F}$	40	mA
Input	*2 Peak transient forward current	I _{FM}	1	Α
	Reverse voltage	VR	5	V
	Power dissipation	Р	35	mW
	Supply voltage	Vcc	-0.5 to +7	V
	Output voltage	Vo	-0.5 to +7	V
Output	Emitter-base reverse withstand voltage (Pin 5 to 7)	V _{EBO}	0.5	v
	*3 Average output current	Io	60	mA
	Power dissipation	Po	100	mW
	*4 Isolation voltage	V _{iso} (rms)	2.5	kV
	Operating temperature	Topr	0 to +70	°C
	Storage temperature	T _{stg}	-55 to +125	°C
	*5 Soldering temperature	T _{sol}	260	°C

*1 50% duty cycle, Pulse width=1ms

*2 Pulse width≤1µs, 300pulse/s

*3 Decreases at the rate of 0.7mA/°C if the external temperature is 25°C or more.

*4 40 to 60% RH, AC for 1 minute

*5 For 10 seconds

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Electro-optical Characteristics

Electro-optical Characteristics		(Ta	=0 to 70°	C unless o	otherwise s	pecified)
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
*6 Current transfer ratio	CTR	$I_{F}=1.6mA$, $V_{O}=0.4V$, $V_{CC}=4.5V$	300	1 600	-	%
Logic (0) output voltage	Vol	$I_0=4.8mA$, $V_{CC}=4.5V$, $I_F=1.6mA$	-	0.1	0.4	v
Logic (1) output current	Іон	$I_F=0, V_{CC}=V_O=7V$	-	0.1	250	μΑ
Logic (0) supply current	ICCL	I _F =1.6mA, V _{CC} =5V, V _O =open	_	0.5	-	mA
Logic (1) supply current	I _{CCH}	IF=0, Vcc=5V, Vo=open	_	10	-	nA
Input forward voltage	VF	I _F =1.6mA, Ta=25°C	_	1.5	1.7	V
Input forward voltage temperature coefficient	*7	I _F =1.6mA	_	-1.9	-	mV/°C
Input reverse voltage	BV _R	I _R =10µA, Ta=25°C	5.0	-	-	v
Input capacitance	CIN	V _F =0, f=1MHz	-	60	-	pF
^{*8} Leak current (input-output)	II-0	Ta=25°C, 45%RH, t=5s V _{I-0} =3kV DC	_	-	1.0	μΑ
^{*8} Isolation resistance (input-output)	R _{I-O}	V _{I-O} =500V DC	-	1012	-	Ω
^{*8} Capacitance (input-output)	C _{I-O}	f=1MHz	-	0.6	-	pF
*6 Current transfer ratio is the ratio of input cu	rrent and ou	tput current expressed in %.	1	Note) Type	value : at T	a=25°C

*6 Current transfer ratio is the ratio of input current and output current expressed in %.

 $*7~\Delta V_{F}\,/\,\Delta T_{a}$

*8 Measured as 2-pin element (Short 1, 2, 3, 4 and 5, 6, 7, 8)

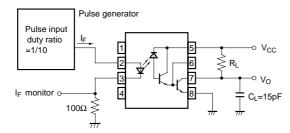
Switching Characteristics

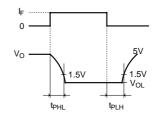
(Ta=25°C, V_{CC} =5V)

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
*9	Propagation delay time Output $(1) \rightarrow (0)$	tPHL	$I_{F} = 1.6mA$ R _L = 2.2kΩ	-	2	10	μs
*9	Propagation delay time Output $(0) \rightarrow (1)$	tplh	$I_{F} = 1.6 m A$ $R_{L} = 2.2 k \Omega$	_	7	35	μs
*10 *11	Instantaneous common mode rejection voltage " output (1) "	CM _H	$ \begin{array}{l} I_{F}=\!0,V_{CM}\!=\!\!10V_{P\!-\!P}\\ R_{L}=\!2.2k\Omega \end{array} $	-	500	-	V/µs
*10 *11	Instantaneous common mode rejection voltage " output (0) "	CML	$I_{F} = 1.6 \text{mA}, V_{CM} = 10 V_{P-P}$ $R_{L} = 2.2 \text{k}\Omega$	_	-500	_	V/µs

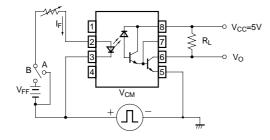
*10 Instantaneous common mode rejection voltage " output (1) " represents a common mode voltage variation that can hold the output above (1) level (V₀>2.0V) Instantaneous common mode rejection voltage " output (0) " represents a common mode voltage variation that can hold the output above (0) level (V_0 <0.8V)

***9 Test Circuit for Propagation Delay Time**





*11 Test Circuit for Instantaneous Common Mode Rejection Voltage



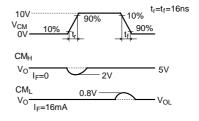
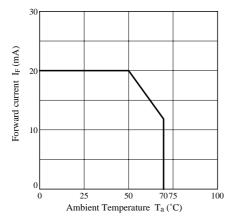


Fig. 1 Forward Current vs. Ambient Temperature





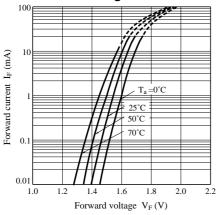


Fig. 2 Power Dissipation vs. Ambient Temperature

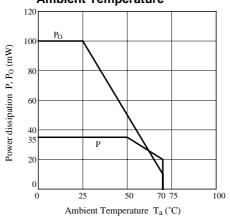
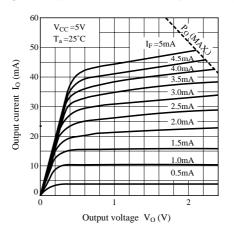
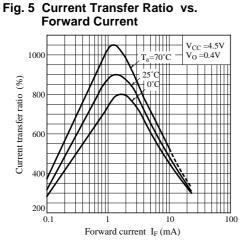
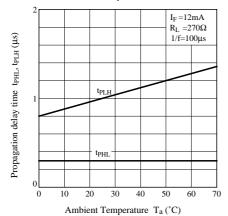


Fig. 4 Output Current vs. Output Voltage

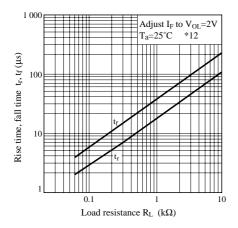












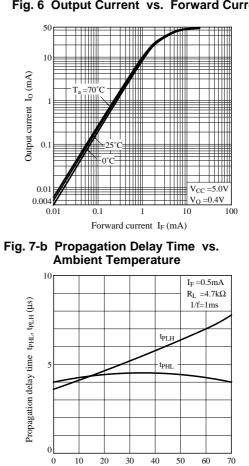
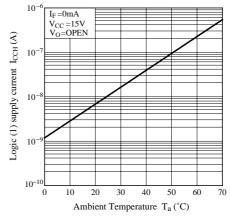
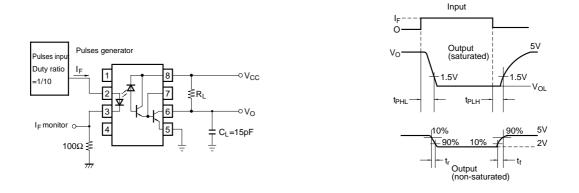


Fig. 6 Output Current vs. Forward Current

Ambient Temperature Ta (°C) Fig. 9 Logic (1) Supply Current vs. Ambient Temperature



*12 Test Circuit for Rise Time, Fall Time vs. Load Resistance



Precaution for use

- (1) It is recommended that a by-pass capacitor of more than 0.01μ F be added between V_{CC} and GND near the device in order to stabilize power supply line.
- (2) Transistor of detector side in bipolar configuration is apt to be affected by static electricity for its minute design. When handling them, general counterplan against static electricity should be taken to avoid breakdown of devices or degradation of characteristics.

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 - Test and measurement equipment
 - Industrial control
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